- Switch ±10-V Analog Signals
- TTL Logic Capability
- 5-to 30-V Supply Ranges
- Low (100 Ω) On-State Resistance
- High (10¹¹ Ω) Off-State Resistance
- 8-Pin Functions

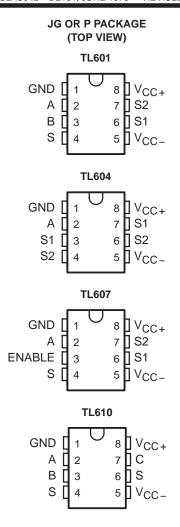
description

The TL601, TL604, TL607, and TL610 are a family of monolithic P-MOS analog switches that provide fast switching speeds with high $r_{\rm off}/r_{\rm on}$ ratio and no offset voltage. The p-channel enhancement-type MOS switches accept analog signals up to $\pm 10~\rm V$ and are controlled by TTL-compatible logic inputs. The monolithic structure is made possible by BI-MOS technology, which combines p-channel MOS with standard bipolar transistors.

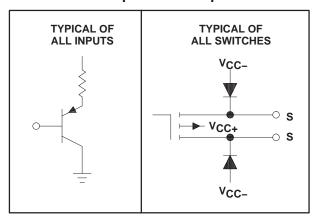
These switches are particularly useful in military, industrial, and commercial applications such as data acquisition, multiplexers, A/D and D/A converters, MODEMS, sample-and-hold signal multiplexing, systems, integrators, operational amplifiers, programmable programmable voltage regulators, crosspoint switching networks, logic interface, and many other analog systems.

The TL601 is an SPDT switch with two logic control inputs. The TL604 is a dual complementary SPST switch with a single control input. The TL607 is an SPDT switch with one logic control input and one enable input. The TL610 is an SPST switch with three logic control inputs. The TL610 features a higher $r_{\rm off}/r_{\rm on}$ ratio than the other members of the family.

The TL601C, TL604C, TL607C, and TL610C are characterized for operation from 0°C to 70°C, the TL601I, TL604I, TL607I, and TL610I are characterized for operation from –25°C to 85°C, and the TL601M, TL604M, TL607M, and TL610M are characterized for operation over the full military temperature range of –55°C to 125°C.



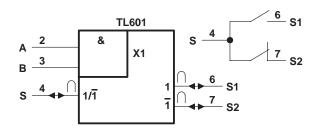
schematics of inputs and outputs

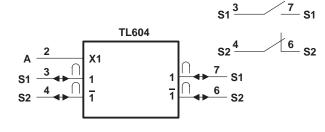


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D2161, JUNE 1976 — REVISED OCTOBER 1986

logic symbols[†] and switch diagrams



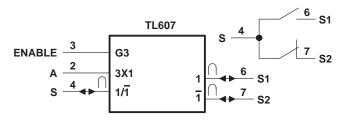


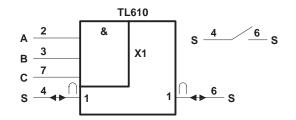
FUNCTION TABLE

INP	UTS	ANALOG SWITCHES				
Α	В	S1	S2			
L	Х	Off (open)	On (closed)			
Х	L	Off (open)	On (closed)			
Н	Н	On (closed)	Off (open)			

FUNCTION TABLE

INPUT	ANALOG	SWITCHES
Α	S1	S2
Н	On (closed)	Off (open)
L	Off (open)	On (closed)





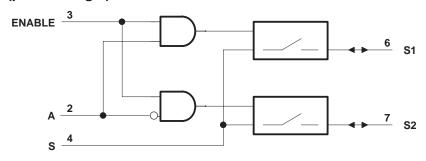
FUNCTION TABLE

11	NPUTS	ANALOG SWITCHES				
Α	ENABLE	S1	S2			
Х	L	Off (open)	Off (open)			
L	Н	Off (open)	On (closed)			
Н	Н	On (closed)	Off (open)			

FUNCTION TABLE

	INPUTS		ANALOG SWITCHES
Α	В	С	S
L	Х	Х	Off (open)
Х	L	Χ	Off (open)
Х	X	L	Off (open)
Х	Н	Н	On (closed)

TL607 logic diagram (positive logic)





[†] These symbols are in accordance with ANSI/IEEE Std 91-1984.

TL601, TL604, TL607, TL610 P-MOS ANALOG SWITCHES

D2161, JUNE 1976 — REVISED OCTOBER 1986

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC+} (see Note 1)	30 V
Supply voltage, V _{CC}	30 V
V _{CC+} to V _{CC-} supply voltage differentia	ıl 35 V
Control input voltage	
Switch off-state voltage	30 V
Switch on-state current	10 mA
Operating free-air temperature range:	TL601C, TL604C, TL607C, TL610C
	TL601I, TL604I, TL607I, TL610I –25°C to 85°C
	TL601M, TL604M, TL607M, TL610M –55°C to 125°C
Storage temperature range	–65°C to 150°C
Lead temperature (1,6 mm) 1/16 inch from	om case for 60 seconds: JG package
Lead temperature (1,6 mm) 1/16 inch from	om case for 10 seconds: P package

NOTE 1: All voltage values are with respect to network ground terminal.

recommended operating conditions

		1	TL601C, TL604C TL607C, TL610C		TL601I, TL604I TL607I, TL610I			TL601M, TL604M TL607M, TL610M			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
Supply voltage, V _{CC+} (see Figure 1)	Supply voltage, V _{CC+} (see Figure 1)			25	5	10	25	5	10	25	V
Supply voltage, V _{CC} (see Figure 1)		-5	-20	-25	-5	-20	-25	-5	-20	-25	V
V _{CC+} to V _{CC-} supply voltage differential (see Figure 1)		15		30	15		30	15		30	V
High-level control input voltage, VIH		2		5.5	2		5.5	2		5.5	V
Low-level control input voltage, VIL	All inputs			0.8			0.8			0.8	
Voltage at any analog switch (S) terminal		VCC-+	8	V _{CC+}	VCC-+8	3	VCC+	VCC-+8	3	VCC+	V
Switch on-state current				10			10			10	mA
Operating free-air temperature, TA		0		70	25		85	-55		125	°C

TL601, TL604, TL607, TL610 P-MOS ANALOG SWITCHES

D2161, JUNE 1976 — REVISED OCTOBER 1986

electrical characteristics over recommended operating free-air temperature range, V_{CC+} = 10 V, V_{CC-} = -20 V, analog switch test current = 1 mA (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]		Т	TL6 C		TL6 M TL6 I			UNIT	
					MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
lн	High-level input current	V _I = 5.5 V			0.5	10		0.5	10	μΑ	
Ι _Ι L	Low-level input current	V _I = 0.4 V				-50	-250		-50	-250	μΑ
1 "	Switch off-state current	$V_{I(SW)} = -10^{\circ}$	V,	T _A = 25°C		-500			-400		pА
loff	Switch on-state current	See Note 2		$T_A = MAX^{\dagger}$		-10	-20		-50	-100	nA
				TL601							
		$V_{I(SW)} = 10 V$		TL604		75	200		55	100	
		$I_{O(sw)} = -1 \text{ m}$	nΑ	TL607							
ron	Switch on-state resistance			TL610		40	100		40	80	Ω
ion	GWIGH OH State resistance			TL601							22
		$V_{I(SW)} = -10 \text{ V},$ $I_{O(SW)} = -1 \text{ mA}$		TL604		220	600		220	400	
				TL607							
				TL610		120	300		120	300	
roff	Switch off-state resistance					20			20		GΩ
Con	Switch on-state input capacitance	$V_{I(SW)} = 0 V$	f = 1 MHz			16			16		pF
Coff	Switch off-state input capacitance	$V_{I(SW)} = 0 V$	f = 1 MHz			8			8		pF
	Supply current from V _{CC+}	Logic		TL601 TL604		5	10		5	10	
I _{CC+}		input(s) at 5.5 V, All switch	ENABLE high	TL607		5	10		5	10	mA
		terminals open	ENABLE low	12007		3	5		3	5	11.0
		·		TL610		5	10		5	10	
		Logic		TL601 TL604		-1.2	-2.5		-1.2	-2.5	
ICC-	Supply current from V _{CC} -	input(s) at 5.5 V, All switch	ENABLE high	TL607		-2.5	-5		-2.5	-5	mA
		terminals open	ENABLE low	12007		-0.05	-0.5		-0.05	-0.5	
		- 1		TL610		-1.2	-2.5		-1.2	-2.5	

 $^{^\}dagger$ MAX is 70°C for C-suffix types, 85°C for I-suffix types, and 125°C for M-suffix types.

 ‡ All typical values are at TA= 25°C except for I_{Off} at TA= MAX. NOTE 2: The other terminal of the switch under test is at V_{CC+} = 10 V.

switching characteristics, $V_{CC+} = 10 \text{ V}$, $V_{CC-} = -20 \text{ V}$, $T_A = 25^{\circ}\text{C}$

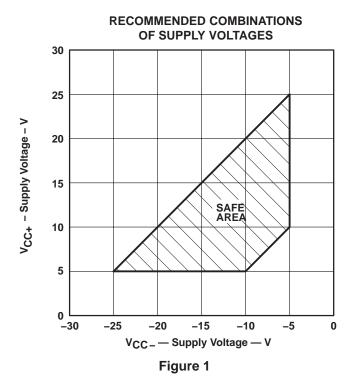
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
toff	Switch turn-off time	D. 41-0 C. 25 r.E. Con Figure 0		400	500	
ton	Switch turn-on time	R_L = 1 kΩ, C_L = 35 pF, See Figure 2		100	150	ns

D2161, JUNE 1976 - REVISED OCTOBER 1986

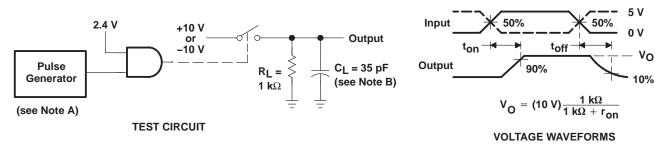
PARAMETER MEASUREMENT INFORMATION

Figure 1 shows power supply boundary conditions for proper operation of the TL601 Series. The range of operation for supply V_{CC+} from 5 V to 25 V is shown on the vertical axis. The range of V_{CC-} from -5 V to -25 V is shown on the horizontal axis. A recommended 30-V maximum voltage differential from V_{CC+} to V_{CC-} governs the maximum V_{CC+} for a chosen V_{CC-} (or vice versa). A minimum recommended difference of 15 V from V_{CC+} to V_{CC-} and the boundaries shown in Figure 1 allow the designer to select the proper combinations of the two supplies.

The designer-selected V_{CC+} supply value for a chosen V_{CC-} supply value limits the maximum input voltage that can be applied to either switch terminal; that is, the input voltage should be between $V_{CC-} + 8 \text{ V}$ and V_{CC+} to keep the on-state resistance within specified limits.



PARAMETER MEASUREMENT INFORMATION

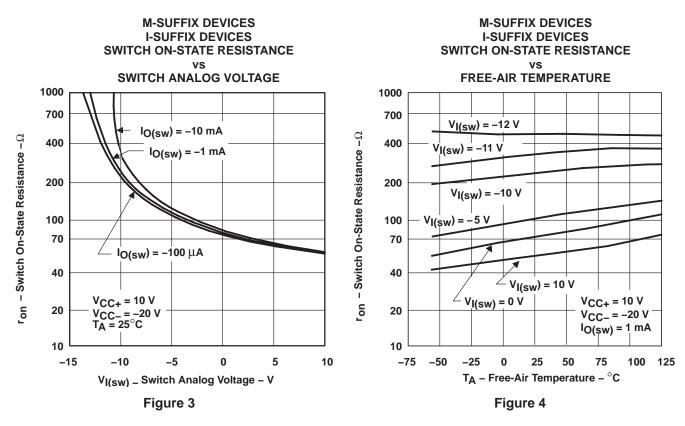


NOTES: A. The pulse generator has the following characteristics: $Z_0 = 50~\Omega, t_f \ge 15~ns, t_f \ge 15~ns, t_W = 500~ns.$

B. C_L includes probe and jig capacitance.

Figure 2

TYPICAL CHARACTERISTICS







i.com 30-Mar-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL601CP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TL601IP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TL604CP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TL607CP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TL610CP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

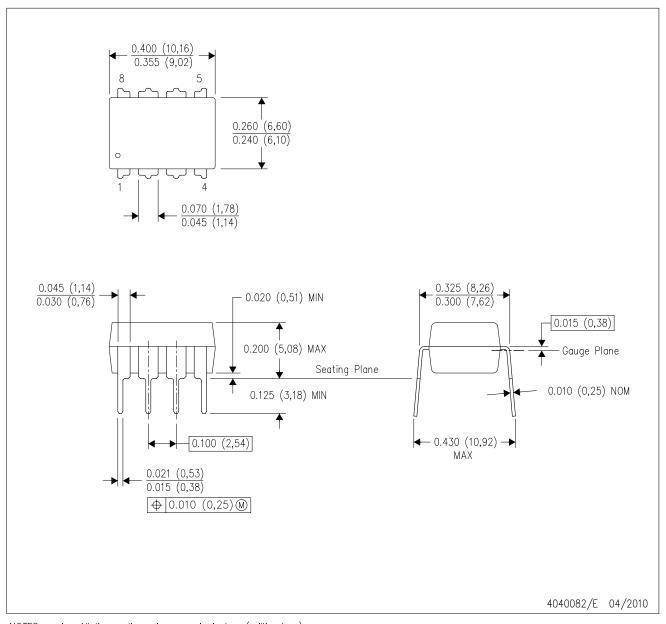
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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